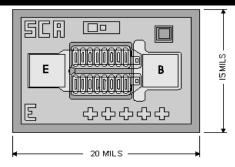


Data Sheet No. 2C3866A

Chip Type 2C3866A Geometry 1007 Polarity NPN **Generic Packaged Parts:** 

**Request Quotation** 

2N3866, 2N3866A



Chip type **2C3866A** by Semicoa Semiconductors provides performance similar to these devices.

## Part Numbers:

2N3866A, 2N3866, 2N3866AUB, SD3866A, SD3866AF, SQ3866AF, SQ3866AF

## **Product Summary:**

**APPLICATIONS:** Designed for amplifier, frequency multiplier and oscillator applications. Suitable for output, driver and predriver stages in VHF and UHF equipment.

## Features: Special Characteristics:

ft = 950 MHz (type) at 50 mA/15V

Mechanical Specifications					
Metallization	Тор	Al - 15 kÅ min.			
	Backside	Au - 6.5 kÅ nom.			
Bonding Pad Size	Emitter	3.4 mils x 3.0 mils			
	Base	3.4 mils x 3.0 mils			
Die Thickness	8 mils nominal				
Chip Area	15 mils x 20 mils				
Top Surface	Silox Passivated				

Electrical Characteristics $T_A = 25^{\circ}C$						
Parameter	Test conditions	Min	Max	Unit		
BV <sub>CEO</sub>	$I_{\rm C} = 5.0  \rm{mA}$	30		V dc		
BV <sub>CBO</sub>	I <sub>C</sub> = 100 μA	55		V dc		
BV <sub>CER</sub>	I <sub>C</sub> = 5.0 mA, R <sub>BE</sub> = 10 Ohms	55		V dc		
BV <sub>EBO</sub>	I <sub>E</sub> = 100 μA	3.5		V dc		
I <sub>CEO</sub>	$V_{CE} = 28 \text{ V}, \text{ V}_{EB} = 2.0 \text{ V}$		20	μA		
h <sub>FE1</sub>	$I_{C} = 360 \text{ mA dc}, V_{CE} = 5.0 \text{ V}$	5.0				
h <sub>FE2</sub>	$I_{C} = 50 \text{ mA dc}, V_{CE} = 5.0 \text{ V}$	10	200			

Due to limitations of probe testing, only dc parameters are tested. This must be done with pulse width less than 300  $\mu$ s, duty cycle less than 2%.

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